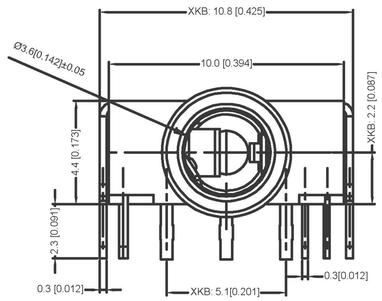
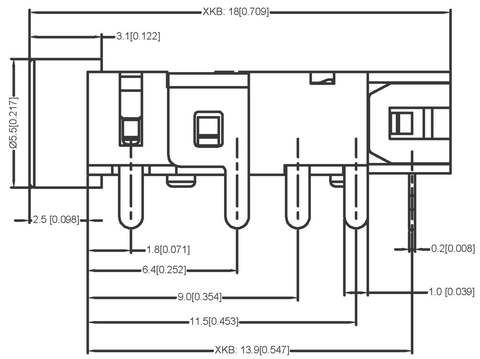
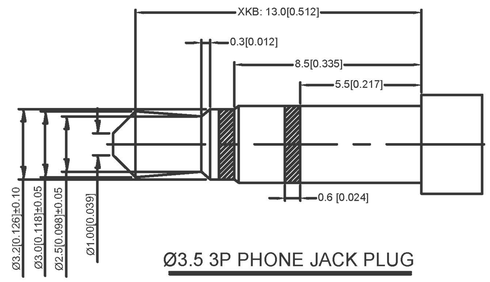
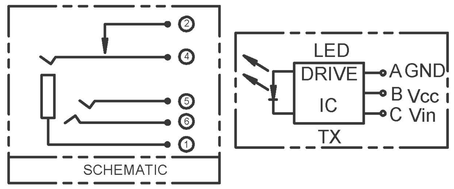


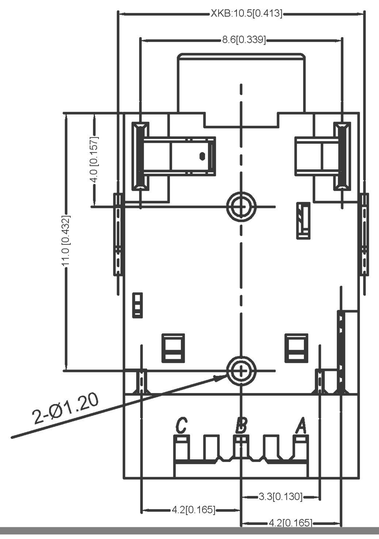


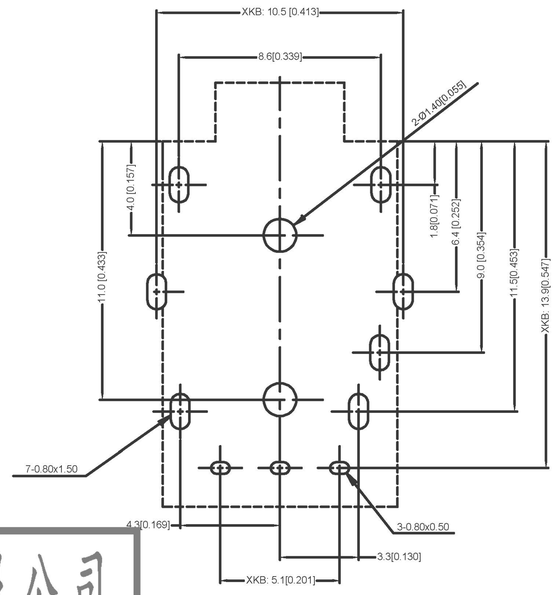


Ø3.5 3P PHONE JACK PLUG

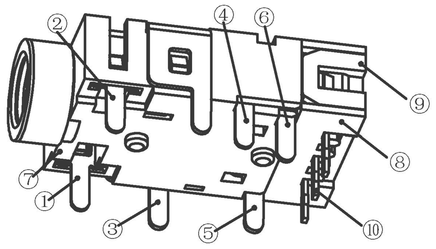
SPECIFICATIONS:
规格:
ELECTRICALCHARACTERS:
电气特性：
1-1.RATING:20V，1A Min.
额定值:20V，1A Min
1-2.CONTACT RESISTANCE
接触电阻
50 MILLIOHMS Max. FOR INITIAL
初始电流最大值为50毫欧姆
80 MILLIOHMS Max AFTER 5000 CYCLES
5000次循环后最大为80毫欧姆
1-3.INSULATION RESISTANCE:100 MEGAOHMS Min.
BY 500V DC AFTER I MINUTE.
绝缘电阻：一分钟后，500V DC的最小电阻为100兆欧姆
1-4. DIELECTRIC WITHSTANDING VOLTAGE500VRMS
AFTER I MINUTE
一分钟后的介电耐受电压500Vrms
2.MECHANICAL CHARACTERISTICS:
机械特性：
2-1.INSERTION FORCE:0.3~3.0 KGF2.94~29.4N)
插入力：0.3~3.0 KGF2.94~29.4N）
2-2. WITHDRAWAL FORCE:0.3~3.0KGF(2.94~29.4N)
拔出力：0.3~3.0KGF（2.94~29.4N）
3. LIFE TEST:5.000 CYCLES MIN.
寿命试验：至少5.000次循环。







PCB LAYOUT BOTTOM VIEW
TOLERANCES:±0.05



No.	PART NAME	QTY	MATERIAL(THICK)	PLATING(COLOR)
⑩	DRIVE IC TX	1	N/A	N/A
⑨	COVER2	1	HICH TEMP. THERMOPLASTIC	Black
⑧	COVER1	1	HICH TEMP. THERMOPLASTIC	Black
⑦	HOUSING	1	HICH TEMP. THERMOPLASTIC	Black
⑥	TERMINAL 6#	1	COPPER ALLOY t=0, 25	Au-Plated
⑤	TERMINAL 5#	1	COPPER ALLOY t=0, 30	Au-Plated
④	TERMINAL 4#	1	COPPER ALLOY t=0, 20	Au-Plated
③	TERMINAL 3#	1	COPPER ALLOY t=0, 20	Au-Plated
②	TERMINAL 2#	1	COPPER ALLOY t=0, 20	Au-Plated
①	TERMINAL 1#	1	COPPER ALLOY t=0, 20	Au-Plated

广东星坤科技股份有限公司

生效日期		
ΔX		
ΔX		
ΔX		
MARK	DESCRIPTION	

文件工程章

			ANGLAR	±5°
DATE	REVISED	APPROVED	X.X	±0.2mm
			X.XX	±0.1mm
			X.XXX	±0.05mm
			UNSPECIFIED TOLERANCES	

REVISIONS

www.xk-dg.cn www.helloxkb.com www.helloxkb.cn

DSND		DATE		SCALE: N/A
DWN		DATE		VIEW:
CHKD		DATE		UNIT: mm/in
APPD		DATE		SIZE: A4

XKB INDUSTRIAL PRECISION CO.,LIMITED

MODEL TYPE: 3.5 PHONE JACK

PART NO.:

DWG NO.: PJ-397D

WEIGHT	SHEET	REVISION
1.0g	1/1	A0